



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Art Unit: 2815  
Examiner: Mr. Joseph H. Nguyen

In re PATENT APPLICATION of:

Applicant : Takashi NOGUCHI )

Serial No. : 10/822,691 )

Filed : April 13, 2004 )

For : HEAT RADIATION STRUCTURE )  
OF SEMICONDUCTOR DEVICE, )  
AND MANUFACTURING )  
METHOD THEREOF )

Atty Ref. : OKI 419 )

**AMENDMENT  
AFTER  
FINAL REJECTION**

\_\_\_\_\_  
July 28, 2008

**Mail Stop AF**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This is responsive to the Office Action of January 28, 2008, the period for reply to which is being extended to expire on July 28, 2008 by a Petition that is being filed concurrently. A Request for Continued Examination (RCE) is also being filed concurrently to relieve the above-identified application of its finally-rejected status.

A fee of \$ 1860 is also being submitted concurrently. Should this remittance be accidentally missing, though, or should any additional fees be needed (including extension of time fees, since Applicant hereby provisionally petitions for any extensions that may be deemed necessary to avoid abandonment), the Director may charge such fees to our Deposit Account number 18-0002.

Please amend the above-identified application as specified on the following pages, and then reconsider the application in view of the Remarks that are presented thereafter.